



2827

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

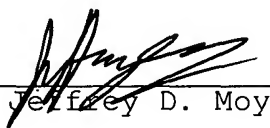
APPLICANT: YOSHIDA, AKITO DOCKET NO.: W2K1077  
SERIAL NO: 10/082,472 EXAMINER: ZARNEKE  
FILED: 02/22/2002 ART UNIT: 2827  
TITLE: A STACKING STRUCTURE FOR SEMICONDUCTOR DEVICES  
USING A FOLDED OVER FLEXIBLE SUBSTRATE AND METHOD  
THEREFOR

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Weiss, Moy & Harris, P.C.  
4204 N. Brown Avenue  
Scottsdale, AZ 85251-3989

August 6, 2003

I hereby certify that on the 6<sup>th</sup> day of August, 2003, this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

  
Jeffrey D. Moy

AMENDMENT

Dear Sir:

This is in response to the Office Action dated May 6, 2003 in regards to the above identified patent application. Please amend the subject patent application as follows: